

July 2008

FGH40N60UFD 600V, 40A Field Stop IGBT

Features

- · High current capability
- Low saturation voltage: V_{CE(sat)} =1.8V @ I_C = 40A
- High input impedance
- Fast switching
- RoHS compliant

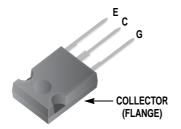
Applications

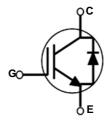
• Induction Heating, UPS, SMPS, PFC



General Description

Using Novel Field Stop IGBT Technology, Fairchild's new sesries of Field Stop IGBTs offer the optimum performance for Induction Heating, UPS, SMPS and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

| Symbol | Description | | Ratings | Units | |
|---------------------|---|--|-------------|-------|--|
| V _{CES} | Collector to Emitter Voltage | | 600 | V | |
| V _{GES} | Gate to Emitter Voltage | | ± 20 | V | |
| I _C | Collector Current | $@ T_C = 25^{\circ}C$ | 80 | А | |
| | Collector Current | $^{\circ}$ T _C = 100 $^{\circ}$ C | 40 | А | |
| I _{CM (1)} | Pulsed Collector Current | @ T _C = 25°C | 120 | А | |
| P_{D} | Maximum Power Dissipation | $@ T_C = 25^{\circ}C$ | 290 | W | |
| | Maximum Power Dissipation | $@ T_C = 100^{\circ}C$ | 116 | W | |
| T _J | Operating Junction Temperature | | -55 to +150 | °C | |
| T _{stg} | Storage Temperature Range | | -55 to +150 | °C | |
| T _L | Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds | | 300 | °C | |

Notes:
1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

| Symbol | Parameter | Тур. | Max. | Units |
|------------------------|---|------|------|-------|
| $R_{\theta JC}(IGBT)$ | Thermal Resistance, Junction to Case | - | 0.43 | °C/W |
| $R_{\theta JC}(Diode)$ | Thermal Resistance, Junction to Case | - | 1.45 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | - | 40 | °C/W |

Package Marking and Ordering Information

| Device Marking | Device | Package | Packaging Type | Qty per Tube | Max Qty per Box |
|----------------|---------------|---------|-------------------|--------------|--------------------|
| FGH40N60UFD | FGH40N60UFDTU | TO-247 | Tube | 30ea | - |

Electrical Characteristics of the IGBT $T_C = 25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|--------------------------------------|--|---|------|------|------|-------|
| Off Charac | teristics | | | | | |
| BV _{CES} | Collector to Emitter Breakdown Voltage | $V_{GE} = 0V, I_{C} = 250\mu A$ | 600 | - | - | V |
| $\frac{\Delta BV_{CES}}{\Delta T_J}$ | Temperature Coefficient of Breakdown Voltage | $V_{GE} = 0V, I_{C} = 250\mu A$ | - | 0.6 | - | V/°C |
| I _{CES} | Collector Cut-Off Current | $V_{CE} = V_{CES}, V_{GE} = 0V$ | - | - | 250 | μА |
| I _{GES} | G-E Leakage Current | $V_{GE} = V_{GES}, V_{CE} = 0V$ | - | = | ±400 | nA |
| On Charac | teristics | | · | | | |
| V _{GE(th)} | G-E Threshold Voltage | $I_{C} = 250 \mu A, V_{CE} = V_{GE}$ | 4.0 | 5.0 | 6.5 | V |
| OL(III) | | I _C = 40A, V _{GE} = 15V | - | 1.8 | 2.4 | V |
| V _{CE(sat)} | Collector to Emitter Saturation Voltage | I _C = 40A, V _{GE} = 15V, T _C = 125°C | - | 2.0 | - | V |
| Dynamic C | haracteristics | | - | ! | | |
| C _{ies} | Input Capacitance | | - | 2110 | - | pF |
| C _{oes} | Output Capacitance | $V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz | - | 200 | - | pF |
| C _{res} | Reverse Transfer Capacitance | - 1 - 11VII 12 | - | 60 | - | pF |
| Switching | Characteristics | | | | | |
| t _{d(on)} | Turn-On Delay Time | | - | 24 | - | ns |
| t _r | Rise Time | | - | 44 | - | ns |
| t _{d(off)} | Turn-Off Delay Time | $V_{CC} = 400V, I_{C} = 40A,$ | - | 112 | - | ns |
| t _f | Fall Time | $R_G = 10\Omega, V_{GE} = 15V,$ | - | 30 | 60 | ns |
| E _{on} | Turn-On Switching Loss | Inductive Load, T _C = 25°C | - | 1.19 | - | mJ |
| E _{off} | Turn-Off Switching Loss | | - | 0.46 | - | mJ |
| E _{ts} | Total Switching Loss | | - | 1.65 | - | mJ |
| t _{d(on)} | Turn-On Delay Time | | - | 24 | - | ns |
| t _r | Rise Time | | - | 45 | - | ns |
| t _{d(off)} | Turn-Off Delay Time | $V_{CC} = 400V, I_{C} = 40A,$ | - | 120 | - | ns |
| t _f | Fall Time | $R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 125^{\circ}C$ | - | 40 | - | ns |
| E _{on} | Turn-On Switching Loss | | - | 1.2 | - | mJ |
| E _{off} | Turn-Off Switching Loss | | - | 0.69 | - | mJ |
| E _{ts} | Total Switching Loss | | - | 1.89 | - | mJ |
| Qg | Total Gate Charge | | - | 120 | - | nC |
| Q _{ge} | Gate to Emitter Charge | $V_{CE} = 400V, I_{C} = 40A,$ $V_{GF} = 15V$ | - | 14 | - | nC |
| Q _{gc} | Gate to Collector Charge | *GE = 10 V | - | 58 | - | nC |

Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | Test Conditions | | Min. | Тур. | Max | Units |
|-----------------|-------------------------------|--|----------------------------------|------|------|-----|-------|
| V _{FM} | Diode Forward Voltage | I I⊏ = 20A | $T_C = 25^{\circ}C$ | - | 1.95 | 2.6 | V |
| | | | $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | 1.85 | - | |
| t _{rr} | Diode Reverse Recovery Time | $I_{ES} = 20A$, $dI_{ES}/dt = 200A/\mu s$ | $T_C = 25^{\circ}C$ | - | 45 | - | ns |
| trr Diode | ŕ | | $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | 140 | ı | |
| Q _{rr} | Diode Reverse Recovery Charge | | $T_{\rm C} = 25^{\rm o}{\rm C}$ | - | 75 | - | nC |
| ~11 | | | $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | 375 | - |] |

Figure 1. Typical Output Characteristics

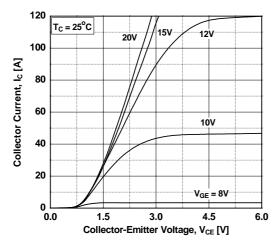


Figure 3. Typical Saturation Voltage Characteristics

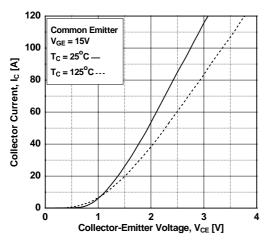


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

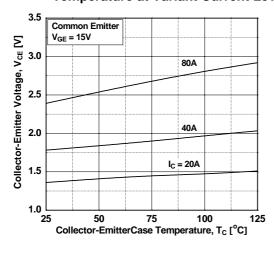


Figure 2. Typical Output Characteristics

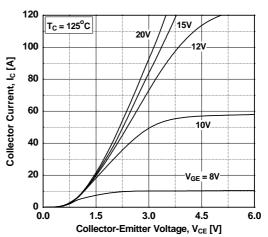


Figure 4. Transfer Characteristics

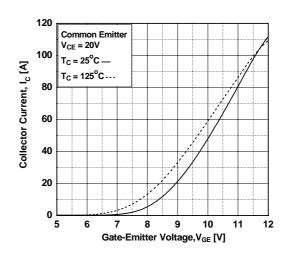


Figure 6. Saturation Voltage vs. V_{GE}

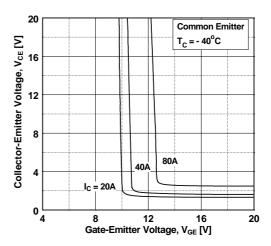


Figure 7. Saturation Voltage vs. V_{GE}

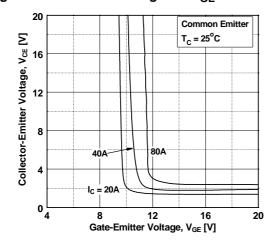


Figure 9. Capacitance Characteristics

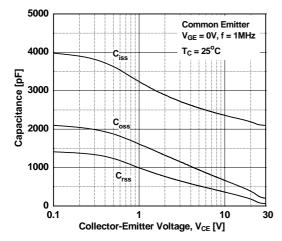


Figure 11. SOA Characteristics

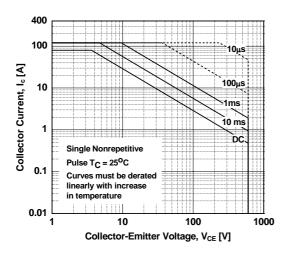


Figure 8. Saturation Voltage vs. V_{GE}

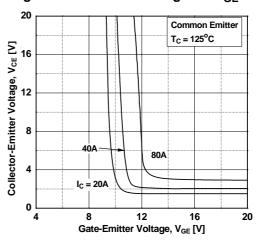


Figure 10. Gate charge Characteristics

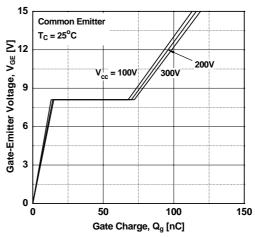


Figure 12. Turn-on Characteristics vs. Gate Resistance

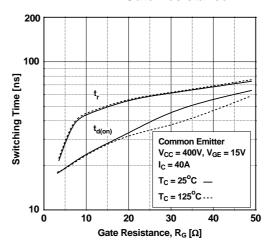


Figure 13. Turn-off Characteristics vs.
Gate Resistance

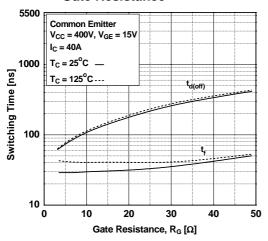


Figure 14. Turn-on Characteristics vs. Collector Current

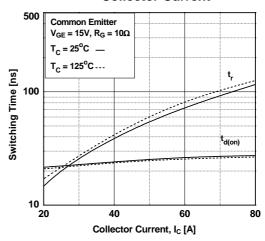


Figure 15. Turn-off Characteristics vs. Collector Current

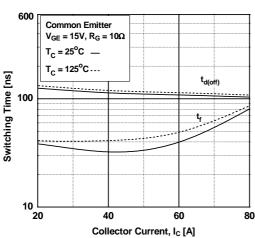


Figure 16. Switching Loss vs. Gate Resistance

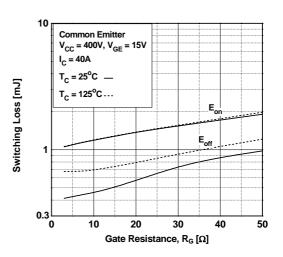


Figure 17. Switching Loss vs. Collector Current

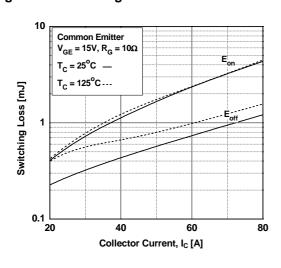


Figure 18. Turn off Switching SOA Characteristics

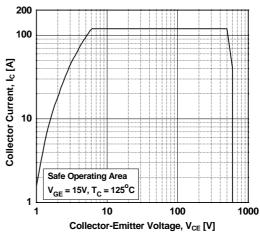


Figure 19. Forward Characteristics

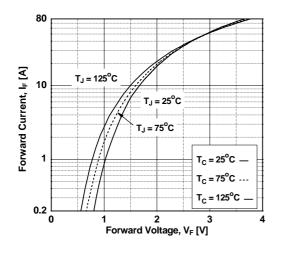


Figure 20. Typical Reverse Current vs. Reverse Voltage

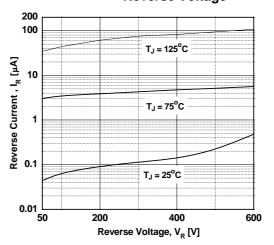


Figure 21. Stored Charge

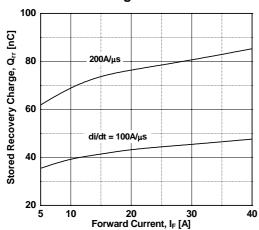


Figure 22. Reverse Recovery Time

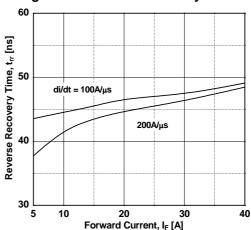
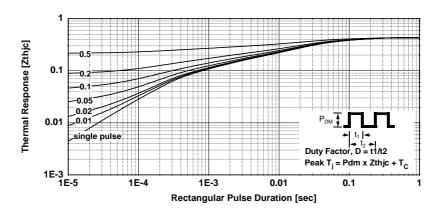
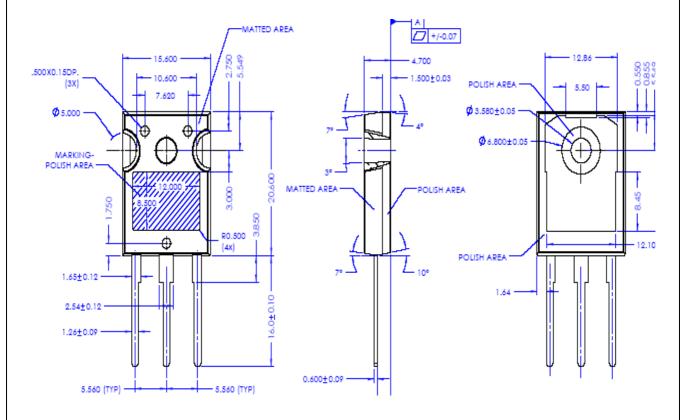


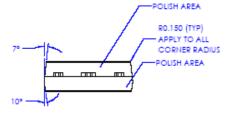
Figure 23. Transient Thermal Impedance of IGBT



Mechanical Dimensions

TO-247AB (FKS PKG CODE 001)





Dimensions in Millimeters





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